

## Sample Approval Sheet

Product type: Chip LED		
Product name: 1206 Yellow Green LED		
Part No.: 1206YGI-001		
Sample No.:		
Acknowledgement Numbers:		
<b>(Signatures)</b>		
<b>核准(Approved)</b>	<b>(Checked)</b>	<b>制定(Drawn)</b>
王娟	周宏	阮国成

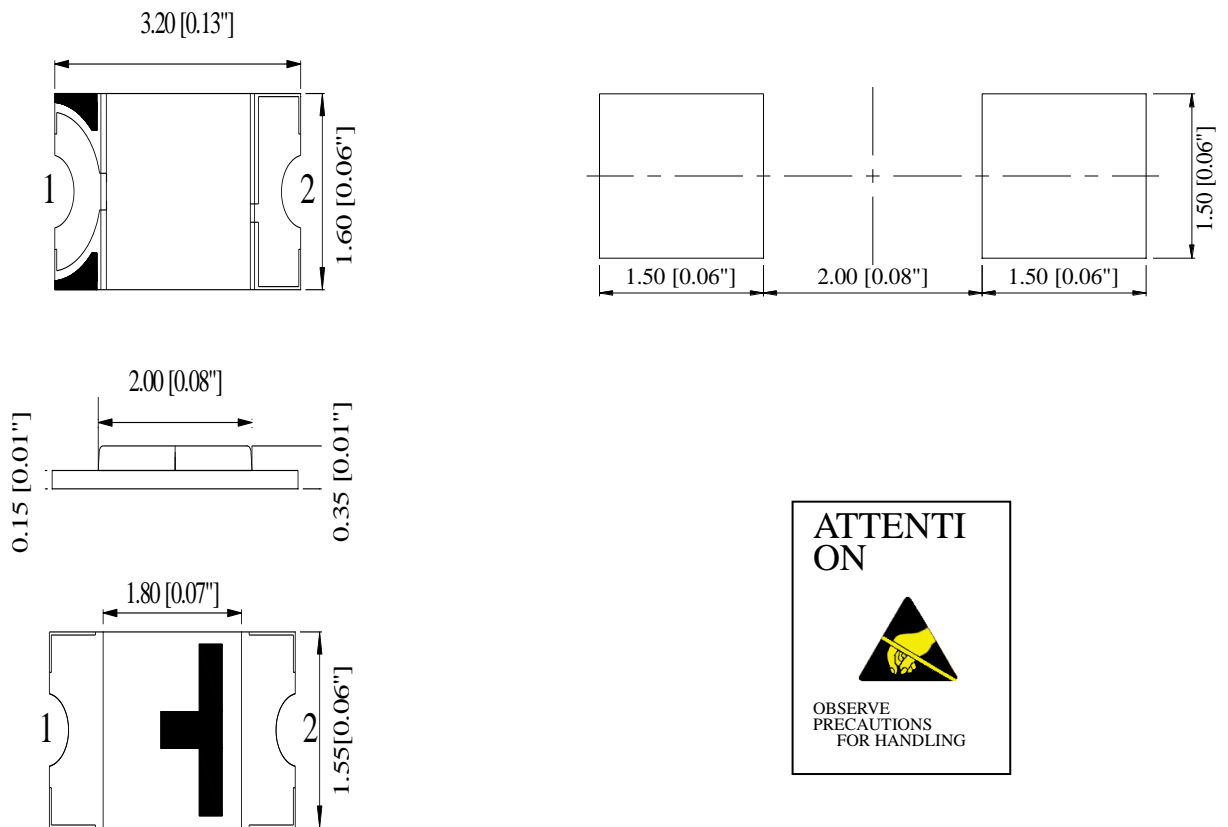
<b>客户 (Customer)</b>		
公司名称(Corporation):		
物料编码(Material No.):		
物料名称(Part No.):		
<b>客户确认 (Customer Signatures)</b>		

Feature

特征

- \*Low power consumption
- \*Long life-solid state reliability
- \*Available on tape and reel
- \*RoHS compliant

## Package outline dimensions



### Note:

1. All dimensions are in millimeters (mm);
2. X.X is +/-0.1mm, X.XX is +/- 0.05mm unless otherwise noted;
3. The device has a single mounting surface, the device must be mounted according to the specifications.

## Electrical characteristics data sheet

### Selection Guide

Part No.	Emitted Color	Resin color	Viewing Angle 2θ <sub>1/2</sub>
1206YGI-001	Yellow Green	Water transparent	130°

### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol (符号)	Value (数值)	Unit (单位)
Power dissipation	Pd	70	mW
DC Forward Current	If	30	mA
Peak Forward Current <sup>(1)</sup>	Ifp	70	mA
Reverse Voltage	Vr	5	V
Electro-Static-Discharge <sup>(2)</sup> (HBM)	ESD	1000	V
Operating Temperature	Topr	-25to+85	°C
Storage Temperature	Tstg	-40to+100	°C
Lead Solder Temperature	Tsol	250 for 5sec	°C

### Notes:

- 1/10 duty cycle, 0.1ms pulse width
2. The products are sensitive to static electricity and must be carefully taken when handling products.

### Electrical/Optical Characteristics Ta=25°C

Parameter	Symbol	Condition	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	VF	If=20mA	1.8	--	2.4	V
Luminous intensity	IV	If=20mA	32	50	--	mcd
Dominant wavelength	WLD	If=20mA	566	--	576	nm
Peak wavelength	WLP	If=20mA	---	573	---	nm
Reverse current	Ir	Vr=5V	---	---	10	μA

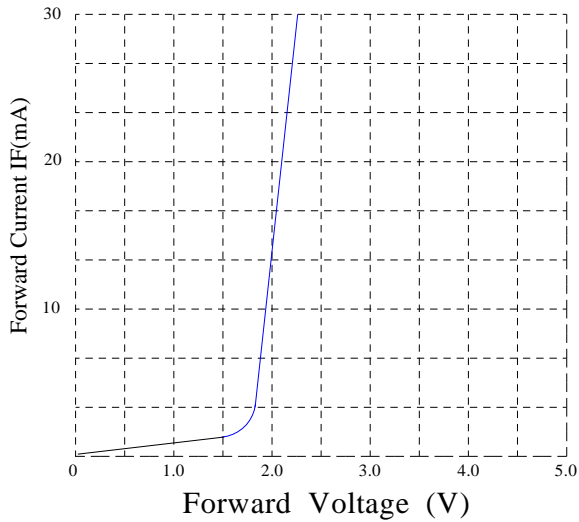
### Notes:

1. Forward voltage: ±0.1V
2. Dominant Wavelength: ±1nm
3. Luminous intensity: ±10%

## Typical Electro-Optical Characteristics Curves

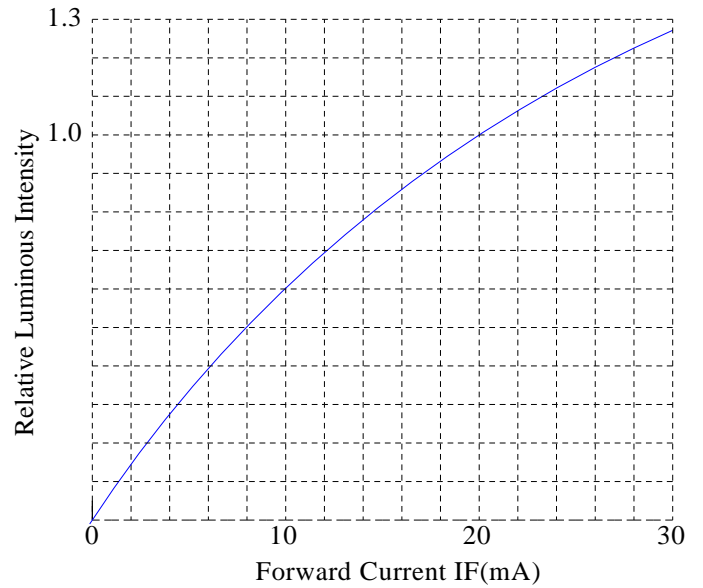
**FORWARD CURRENT VS. FORWARD VOLTAGE**

电流与电压的关系图

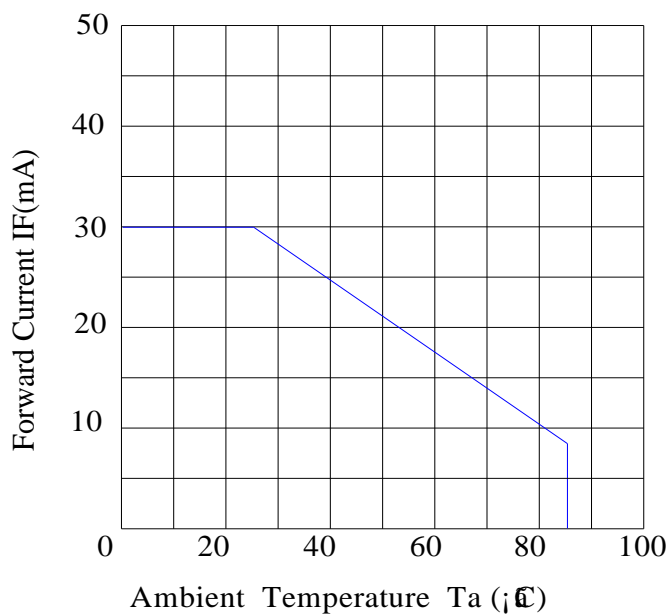


**FORWARD CURRENT VS. LUMINOUS INTENSITY**

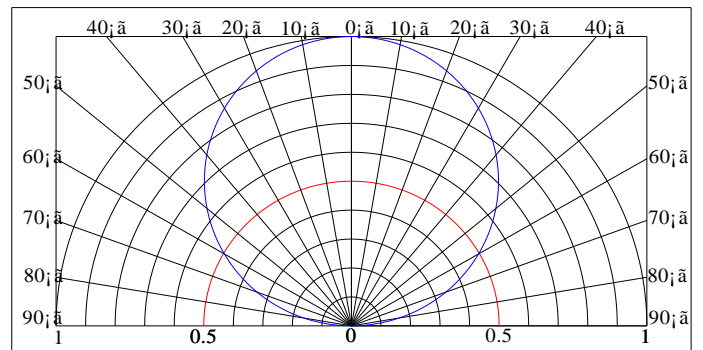
电流与光强的关系图



**AMBIENT TEMPERATURE VS. FORWARD CURRENT**  
电流与温度的关系图



**RADIATION DIAGRAM**  
视角图



## Bin Range of Technical Data Sheet

Voltage code (电压等级) (IF=20mA, Ta=25°C)			Luminous code(光强等级) (IF=20mA, Ta=25°C)		
Bin Code	Forward voltage (V)		Bin Code	Luminous Intensity (mcd)	
	min	max		min	max
11	1.8	2	G	32	40
12	2	2.2	H	40	50
13	2.2	2.4	I	50	63
			J	63	80

### Color Bin Limits

Color code (颜色等级) (IF=20mA, Ta=25°C)		
Bin Code	Dominant wavelength (nm)	
	min	max
YG8	566	568
YG9	568	570
YG10	570	572
YG11	572	574
YG12	574	576

#### Notes:

- 1、Tolerance of forward voltage for each Bin limit is  $\pm 0.1$ v.
- 2、Tolerance of luminous intensity for each Bin limit is  $\pm 10\%$ .
- 3、Tolerance of wavelength for each Bin limit is  $\pm 1$ nm.

## Reliability Test Items and Conditions(可靠性试验及条件)

### 1、Test items and result(测试项目及结果)

Test Item 测试项目	Ref. Standard 参考标准	Test Condition 测试条件	Note 记录	Number of Damaged 受损数量
Resistance to Soldering Heat (耐热测试)	JESD22-B106	Tsld=260°C,10sec	2 times	0/100
Temperature Cycle (冷热循环)	JESD22-A104	-40°C 30min ↓↑ 5min 100°C 30min	10 cycle	0/100
Thermal Shock (冷热冲击)	JESD22-A106	-40°C 15min ↑↓ 100°C 15min	10 cycle	0/100
Power temperature Cycling (高低温点亮循环测试)	JESD22-A105	On 5min -40°C>15min ↑↓↑↓<15min Off 5min 100°C>15min	10 cycle	0/100
High temperature Storage (高温储存)	JESD22-A103	Ta=100°C	1000 hrs	0/100
Low temperature Storage	JESD22-A119	Ta=-40°C	1000 hrs	0/100
Lift Test	JESD22-A108	Ta=25°C IF=20mA	1000 hrs	0/20
High Humidity Heat Lift Test	JESD22-A101	60°C RH=90% IF=20mA	1000 hrs	0/20

### 2、Criteria for judging damage

Item 项目	Symbol 符号	Test Conditions 测试条件	Criteria for Judgment 判断标准	
			Min 最小	Max 最大
Forward voltage	VF	IF=20mA	--	U.S.L*)×1.1
Reverse current	IR	VR=5V	--	U.S.L*)×2.0
Luminous intensity	IV	IF=20mA	L.S.L**)×0.7	--

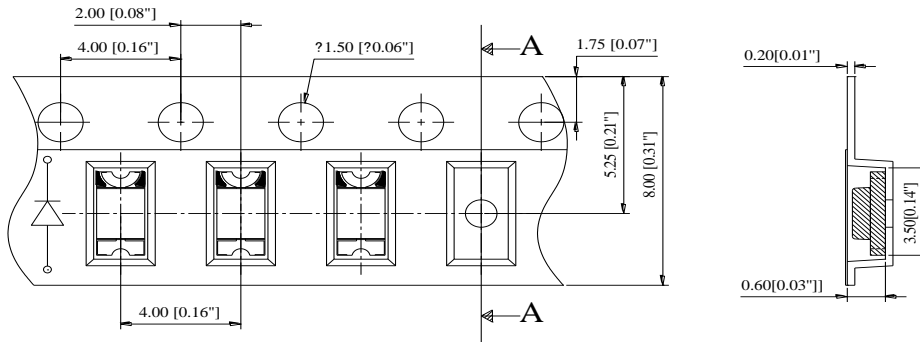
**Notes:**

U.S.L.: Upper Standard Level

L.S.L.: Lower Standard Level

## Packaging Dimensions Specification

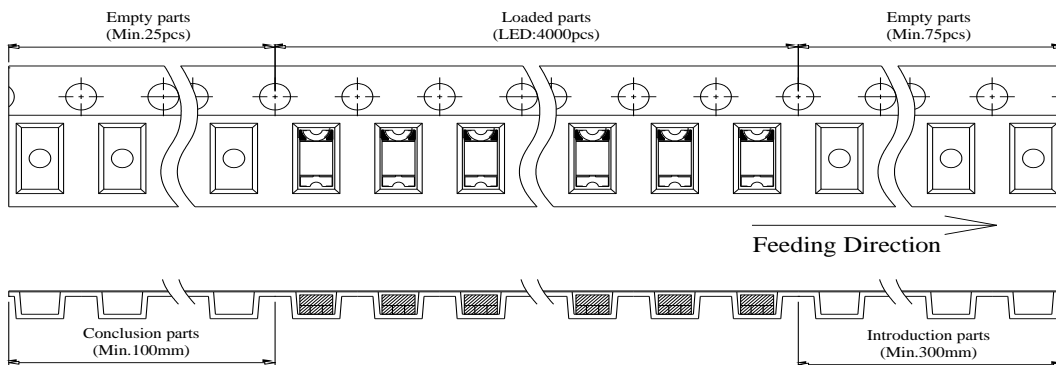
### 1、Carrier tape dimensions



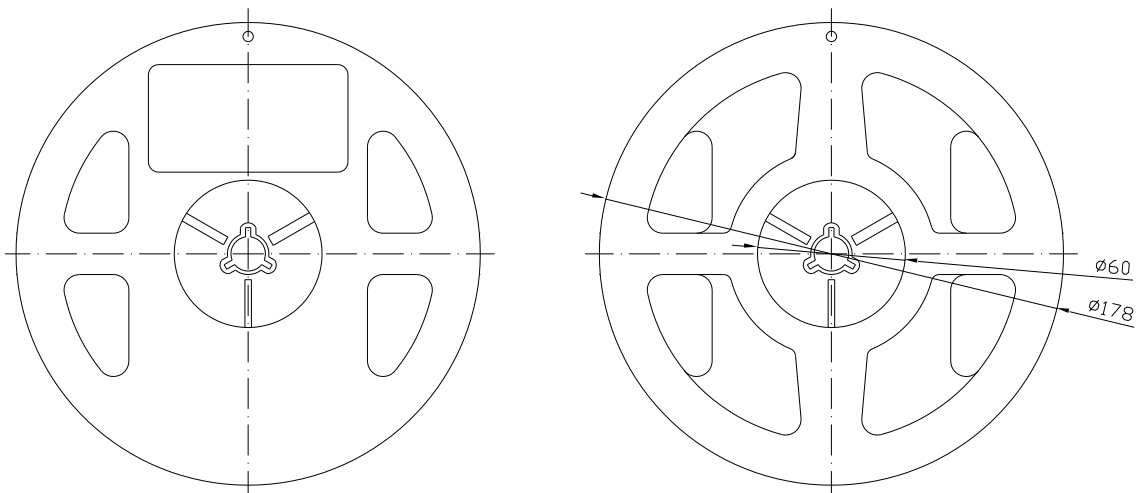
#### Notes:

- 1) All dimensions are in millimeters
- 2) Tolerance is  $\pm 0.15$  unless otherwise noted
- 3) 3,000 pcs/Reel.

### 2、Details of carrier tape

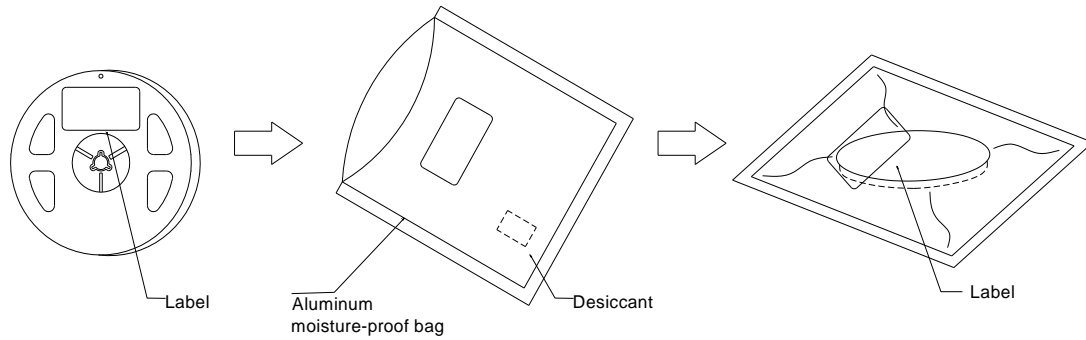


### 3、Reel dimensions



## Packaging Dimensions Specification

### 4、Moisture-Proof and anti-static electricity



### 5、Label(标签)

BEELED	<b>RoHS</b>
Part No. :1206YGI-001	
VF (v) :*****	
IV (mcd) :*****	
WLD (nm) :*****	
Q' TY (pcs) :*****	
Lot No. :*****	Made In China

#### Label Explanation:

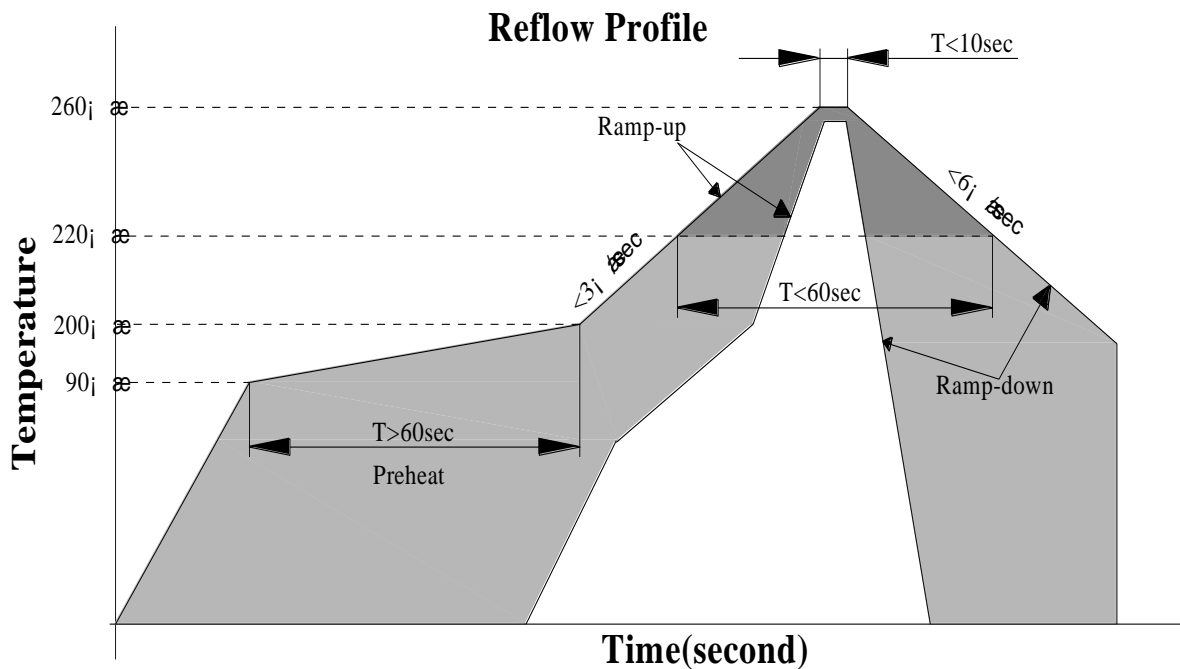
VF	: Forward voltage
IV	: Luminous intensity
WLD	: Dominant wavelength
VF\IV\WLD used to represent the corresponding Bin code	

## Precautions

### 1、Requirements for application and reflow soldering:

Use the recommended curve in the under figure of Pb-free reflow soldering.





☆**Notes for reflow soldering:**

- 1) No more than twice for reflow soldering.
- 2) To ensure the quality of our LEDs, please do not put pressure on the lens of LEDs.
- 3) Please choose the right nozzle to avoid the damage to products due to the pressure.
- 4) Please put on the antistatic hand loop during the use. The worktable should be with antistatic finish. The equipments must be contacted with ground

☆**Handwork soldering:**

- 1) During the soldering, the electronic soldering iron must be kept under the temperature of 350°C and the soldering time must not be beyond 3 seconds. No touch between the electronic soldering iron and colloid.
- 2) Handwork soldering is only allowed once. We won't take responsibility for more than that.
- 3) Avoid using sharp objects to compress products Colloidal Part directly.
- 4) Please put on the antistatic hand loop during the use. The worktable should be with antistatic finish. The equipments must be contacted with ground.

**2、 Storage**

- ☆Moisture proof and anti-electrostatic package with moisture absorbent material is used to keep moisture to a minimum. Before opening the package, the product should be kept at 30°C or less and humidity less than 60%RH ,and be used in six months.
- ☆After opening the package, the product should be stored at 30°C or less and humidity less than 10%RH,and be soldered within 24 hours. It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.
- ☆If the moisture absorbent material has fade away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition(75±5) °C for 24 hour.

**3、 Static electricity**

- ☆Static electricity or surge voltage damages the LEDs .Damaged LEDs will show some unusual characteristic such as the forward voltage comes lower, or the LEDs do not light at the low current .even not light.
- All devices, equipment and machinery must be properly grounded. At the same time ,it is recommended that wrist bands or

anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs .

#### **4、Vulcanization**

☆LED curing is due to sulfur being in bracket and the +1 price of silver in the chemical reaction generated Ag<sub>2</sub>S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperature drift and serious decline, Seriously affecting the performance of the product. So we should take corresponding measures to avoiding vulcanization, Such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.

#### **5、Safety advice for human eyes**

☆Viewing direct to the light emitting center of the LEDs, especially those of great luminous Intensity will cause great hazard to human eyes .Please be careful.

#### **6、Design consideration**

☆In designing a circuit about LED, the current through each LED must not exceed the absolute maximum rating specified for each LED. In the meanwhile, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen.